

Summit Wireless Technologies to Present at the Rocky Mountain Microcap Conference VIII

SAN JOSE, Calif.--(BUSINESS WIRE)-- Summit Wireless Technologies, Inc. (Nasdaq: WISA), a leading provider of immersive, wireless sound technology for intelligent devices and next-generation home entertainment systems, plans to participate in the Rocky Mountain Microcap Conference VIII.

President and CEO Brett Moyer will present at the Rocky Mountain Microcap Conference VIII on Wednesday, November 3 at 1:12 PM PT/ 4:12 PM ET at TopGolf in Centennial Colorado. To view the presentation live or after the fact, please use the virtual conference signup/registration <https://rockymountain21.mysequire.com/>.

Presentation materials and associated webcasts will be posted on the Investor Relations portion of the company's website at www.summitwireless.com.

About Summit Wireless Technologies, Inc.

Summit Wireless Technologies, Inc. (NASDAQ: WISA) is a leading provider of immersive, wireless sound technology for intelligent devices and next-generation home entertainment systems. Working with leading CE brands and manufacturers such as Harman International, a division of Samsung, LG Electronics, Klipsch, Bang & Olufsen, Xbox, a subsidiary of Microsoft, and others, Summit Wireless delivers seamless, dynamic audio experiences for high-definition content, including movies and video, music, sports, gaming/esports, and more. Summit Wireless is a founding member of WiSA, the Wireless Speaker and Audio Association and works in joint partnership to champion the most reliable interoperability standard across the audio industry. Summit Wireless is headquartered in San Jose, CA with sales teams in Taiwan, China, Japan, and Korea. For more information, please visit: www.summitwireless.com.

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Source: Summit Wireless Technologies, Inc.